

Specification of Automotive MLCC (Referance sheet)

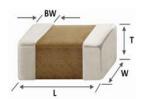


● Supplier : Samsung Electro-Mechanics ● Samsung P/N : CL31B225KAHVPNE

● AEC-Q200 Qualified

A. Dimension

Dimension



Size	1206 inch				
L	3.20±0.20 mm				
W	1.60±0.20 mm				
Т	1.60±0.20 mm				
BW	0.50±0.30 mm				

B. Samsung Part Number

<u>CL</u>	<u>31</u>	<u>B</u>	<u>225</u>	<u>K</u>	<u>A</u>	<u>H</u>	<u>v</u>	<u>P</u>	<u>N</u>	<u>E</u>
1	2	3	4	(5)	6	⑦	8	9	10	11

① Series	Samsung Multi-layer Ceramic Capacitor		
② Size	1206 (inch code)	L: 3.20±0.20 mm	W :1.60±0.20 mm
3 Dielectric	X7R	® Inner electrode	Ni
Capacitance	2.2 μF	Termination	Metal-Epoxy
⑤ Capacitance	± 10%	Plating	Sn 100% (Pb Free)
tolerance		9 Product	Automotive
6 Rated Voltage	25 V	Special code	Normal
7 Thickness	1.60±0.20 mm	① Packaging	Embossed Type, 7" Reel

C. Reliability Test and Judgement condition

Test items	Performance	Test condition				
High Temperature	Appearance : No abnormal exterior appearance	Unpowered, 1,000hrs @ Max. temperature				
Exposure	Capacitance Change Within ±10 %	Measurement at 24±2hrs after test conclusion				
	Tan δ :0.03 max.					
	IR∶More than 10,000 MΩ or 500 MΩ×μF	Initial Measurement 2*				
	Whichever is smaller	Final Measurement 3*				
Temperature Cycling	Appearance : No abnormal exterior appearance	1,000Cycles				
	Capacitance Change Within ±10 %	Initial Measurement 2*				
	Tan δ :0.03 max.	Final Measurement 3*				
	IR∶ More than 10,000 MΩ or 500 MΩ×μF	Measurement at 24±2hrs after test conclusion				
	Whichever is smaller	1 cycle condition : -55+0/-3 °C (30±3min) → Room Temp. (1min)				
		→ 125+3/-0 °C (30±3min) → Room Temp. (1min)				
Destructive Physical	No Defects or abnormalities	Per EIA 469				
Analysis						
Humidity Bias	Appearance : No abnormal exterior appearance	1,000hrs 85 ℃/85%RH, Rated Voltage and 1.3~1.5V,				
	Capacitance Change Within ±12.5 %	Add 100kohm resistor				
	Tan δ : 0.035 max.	Initial Measurement 2*				
	IR ∶More than 500 MΩ or 25 MΩ×μF	Final Measurement 4*				
	Whichever is smaller	Measurement at 24±2hrs after test conclusion				
		The charge/discharge current is less than 50mA.				
High Temperature	Appearance : No abnormal exterior appearance	1,000hrs @ 125℃, 200% Rated Voltage,				
Operating Life	Capacitance Change Within ±12.5 %	Initial Measurement 2*				
	Tan δ :0.035 max.	Final Measurement 4*				
	IR∶More than 1,000 № or 50 №× <i>µ</i> F	Measurement at 24±2hrs after test conclusion				
	Whichever is smaller	The charge/discharge current is less than 50mA.				

	Performance	Test conditi				วท		
External Visual	No abnormal exterior appearance	Microscope ('10)						
Physical Dimension	Within the specified dimensions	Using The calipers						
Mechanical Shock	Appearance : No abnormal exterior appearance	Three shocks in each direction should be applied along						
	Capacitance Change Within ±10 %	3 mutually perpendicular axes of the test specimen (18 shocks)						
	Tan δ, IR : Initial spec.	Peak value Duration Wave Velocity				Velocity		
			1,500G	0.5ms	Half sine	4.7m/sec		
		Initial Measurement 2*						
		Final Measurement 5*						
Vibration	Appearance : No abnormal exterior appearance	5g's for 20min., 12cycles each of 3 orientations,						
	Capacitance Change Within ±10 %	Use 8"	'×5" PCB 0.	.031" Thick	7 secure p	oints on one lo	ong side	
	Tan δ, IR : Initial spec.	and 2	secure poir	nts at corne	rs of oppos	site sides. Part	s mounted	
		within 2	2" from any	secure po	int. Test fro	om 10~2,000Hz		
		Initial N	Measureme	ent 2*				
		Final M	/leasureme	nt 5*				
Resistance to	Appearance : No abnormal exterior appearance	prehea	ating : 150°0	C for 60~12	.0 sec.			
Solder Heat	Capacitance Change Within ±10 %	preheating : 150°C for 60~120 sec. Solder pot : 260±5°C, 10±1sec.						
	Tan δ, IR : Initial spec.	Initial Measurement 2*						
		Final Measurement 3*						
ESD	Appearance : No abnormal exterior appearance	AEC-Q200-002 or ISO/DIS10605						
	Capacitance Change Within ±10 %	Initial Measurement 2*						
	Tan δ, IR : Initial spec.	Final Measurement 4*						
Solderability	95% of the terminations is to be soldered	a) Preheat at 155°C for 4 hours, Immerse in solder for 5s at 245±5						
	evenly and continuously	b) Steam aging for 8 hours, Immerse in solder for 5s at 245±5 $^{\circ}\mathrm{C}$					at 245±5℃	
		c) Steam aging for 8 hours, Immerse in solder for 120s at 260±5 $^{\circ}\mathrm{C}$					s at 260±5℃	
		solder : a solution ethanol and rosin						
Electrical	Capacitance : Within specified tolerance	*A capacitor prior to measuring the capacitance is heat treated at					it treated at	
Characterization	Tan δ : 0.025 max.	150 +0/-10 ℃ for 1hour and maintained in ambient air for 24±2 hou					for 24±2 hours	
	IR(25℃): More than 10,000 № or 500 №× <i>µ</i> F	The Capacitance / D.F. should be measured at 25 $^{\circ}\mathrm{C}$,						
	Whichever is smaller	1 kHz ± 10%, 1 ± 0.2 Vrms						
	IR(125℃) More than 1,000 № or 10 № × μF	I.R. should be measured with a DC voltage not exceeding					ding	
	Whichever is smaller	Rated	Voltage @:	25℃, @12	5℃ for 60	~120 sec.		
	Dielectric Strength	Dielectric Strength : 250% of the rated voltage for 1~5 seconds					seconds	
Board Flex	Appearance : No abnormal exterior appearance	Bending to the limit, 3 mm for 60 seconds 1*						
	Capacitance Change Within ±10 %	Initial N	Measureme	ent 2*				
		Final Measurement 5*						
Terminal	Appearance : No abnormal exterior appearance	18 N,	for 60 sec.					
Strength(SMD)	Capacitance Change Within ±10 %	Initial N	Measureme	ent 2*				
		Final Measurement 5*						
Beam Load	Destruction value should be exceed 54.5 N	54.5 N Beam speed: 2.5±0.25 mm/sec						
Temperature	X7R							
Characteristics	From -55 $^{\circ}$ C to 125 $^{\circ}$ C, Capacitance change shou	d be wit	thin ±15%					

D. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260 +0/-5°C, 30sec.), Meet IPC/JEDEC J-STD-020 D Standard

- *1 : The figure indicates typical specification. Please refer to individual specifications.
- *2 : Initial measurement : Perform a heat treatment at 150 +0/-10 $^\circ\!\! C$ for one hour after soldering process. and then let sit for 24±2 hours at room temperature. Perform the initial measurement.
- $^{\star}3$: Final measurement : Let sit for 24 \pm 2 hours at room temperature after test conclusion, then measure.
- *4 : Final measurement : Perform a heat treatment at 150 +0/-10 °C for one hour after soldering process. and then let sit for 24±2 hours at room temperature. Perform the initial measurement.
- *5 : Final measurement : Let measure within 24 hours at room temperature after test conclusion.



A Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

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- ② Medical equipment
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- 4 Disaster prevention/crime prevention equipment
- ⑤ Power plant control equipment
- 6 Atomic energy-related equipment
- ① Undersea equipment
- 8 Traffic signal equipment
- Data-processing equipment
- @ Electric heating apparatus, burning equipment
- Safety equipment
- @ Any other applications with the same as or similar complexity or reliability to the applications